PCN Number:	2023	0201000.1	PCN Date: February 01, 2023							
Title: Qualification of DMOS6 as an additional Fab site option for select devices										
Customer Conta	ct: <u>PC</u>	IN Manager			uality Services					
Proposed 1 st Sh		ay 1, 2023	accept	ed until:	ır 1, 2023*					
*Sample requests received after March 1, 2023 will not be supported.										
Change Type:										
Assembly Sit	e	Assembly Pr		Assembly Materials Mechanical Specification						
Design Test Site		Electrical Sp	ping/Labeling		Test Process					
Wafer Bump	Site	Wafer Bump			Wafer Bump Process					
Wafer Fab Site		Wafer Fab M			Wafer Fab Process					
		Part number	change							
PCN Details										
Description of C										
Texas Instrument										
additional Wafer I	-ab source for	the selected devi	ces listed in the	e "Product Affect	ed" section.					
Cu	ırrent Fab Sit	e		Additional Fab	Site					
Current Fab	Process	Wafer	New Fab	Process	Wafer					
Site		Diameter	Site		Diameter					
RFAB	LBC8LV	300mm	DMOS6	LBC8LV	300mm					
	Qual details are provided in the Qual Data Section.									
Reason for Chai	nge:									
Continuity of supply.										
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):										
None										
Changes to product identification resulting from this PCN:										
Fab Site Information:										
Chip Site		rigin Code (20L)	Chip Site Cou	Chip Site City Richardson						
	RFAB RFB			USA USA						
DMOS6		DM6		Dallas						
Sample product shipping label (not actual product label)										
INSTRUMENTS G4 MADE IN: Malaysia G4 2DC: 2Q: MSL '2 /260C/1 YEAR SEAL DT 03/29/04 OPT: 1 / 235C/UNLIM OPT: 39 LBL: 5A (L)T0:1750 Image: Construction of the second of										
Product Affecte					SVEET					
DRV2624YFFR DRV2624YFFT DRV2625YFFR DRV2625YFFT										

Qualification Report Approve Date 11-DECEMBER -2022

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: DRV2625YFFR	Qual Device: DRV2624YFFR	QBS Reference: PTPS65830YFFR	QBS Reference: ADS131B04QPWRQ1
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	-	3/231/0
UHAST	A3	Unbiased HAST	130C/85%RH	96 Hours	-	-	3/228/0	3/231/0
тс	A4	Temperature Cycle	-55C/125C	700 Cycles	-	-	3/229/0	1/77/0
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	-	2/154/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	-	1/45/0
HTOL	B1	Life Test	150C	300 Hours	-	-	3/231/0	-
HTOL	B1	Life Test	150C	408 Hours	-	-	-	3/231/0
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	-	-	2/1600/0
ELFR	B2	Early Life Failure Rate	150C	48 Hours	-	-	-	1/800/2 ¹
ESD	E2	ESD CDM	-	250 Volts	1/3/0	-	-	-
ESD	E2	ESD HBM	-	1000 Volts	1/3/0	-	-	-
LU	E4	Latch-Up	Per JESD78	-	1/3/0	-	3/18/0	-
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	-	-

QBS: Qual By Similarity

Qual Device DRV2625YFFR is qualified at MSL1 260C

Qual Device DRV2624YFFR is qualified at MSL1 260C

Qual Device DRV2625YFFT is qualified at MSL1 260C

Qual Device DRV2624YFFT is qualified at MSL1 260C

• Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

• The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

[1]-Discounted

For questions regarding this notice, e-mails can be sent to the contact below or your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	<u>PCN ww admin team@list.ti.com</u>

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use

these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disdaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (<u>www.ti.com/legal/termsofsale.html</u>) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.